

<b>PATENT ASSIGNMENT COVER SHEET</b>
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Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6394760

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MATTHEW MICHAEL DAY	10/19/2020
SAMIRA BINTE KAZEMI	10/16/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SPTS TECHNOLOGIES LIMITED
<b>Street Address:</b>	COED RHEDYN
<b>Internal Address:</b>	RINGLAND WAY
<b>City:</b>	NEWPORT
<b>State/Country:</b>	UNITED KINGDOM
<b>Postal Code:</b>	NP18 2TA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17094759
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	7168564000
<b>Email:</b>	ipdocketing@hodgsonruss.com
<b>Correspondent Name:</b>	KLA CORPORATION / HODGSON RUSS LLP
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<b>Address Line 4:</b>	BUFFALO, NEW YORK 14202-4040
<b>ATTORNEY DOCKET NUMBER:</b>	078697.00471^SP6662US
<b>NAME OF SUBMITTER:</b>	NATHANIEL LUCEK
<b>SIGNATURE:</b>	/nathaniel lucek 60766/
<b>DATE SIGNED:</b>	11/10/2020
<b>Total Attachments: 4</b>	
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**ASSIGNMENT**

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, **Matthew Michael Day**, having an address at c/o SPTS Technologies Limited, Coed Rhedyn, Ringland Way, Newport, NP18 2TA, Great Britain; and **Samira Binte Kazemi**, having an address at c/o SPTS Technologies Limited, Coed Rhedyn, Ringland Way, Newport, NP18 2TA, Great Britain, the undersigned

Hereby sell, assign and transfer to **SPTS Technologies Limited**, having a place of business at Coed Rhedyn, Ringland Way, Newport, NP18 2TA, Great Britain, its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions disclosed in the following patent applications:

Country	Patent Application No.	Filing Date	Title
GB	1918333.4	December 12, 2019	A Semiconductor Wafer Dicing Process

And in and to said applications and all applications that claim priority to any of the aforementioned applications including all divisional, continuation, reissue, and continuation-in-part applications, or national or regional phase applications thereof, which have been or shall be filed in the United States and all foreign countries on any of said inventions; all rights of priority to any of the aforementioned applications; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said inventions;

Agree that said Assignee may apply for and receive Patents for said inventions in its own name; and agree that, when requested, shall execute all rightful oaths or declarations, assignments, powers of attorney, and other papers and generally do everything possible which

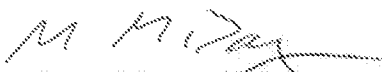
Assignment to SP6662US

said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing, maintaining, and enforcing proper patent protection for said inventions; and

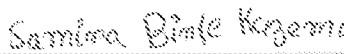
Covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN WITNESS WHEREOF, the undersigned have caused this Assignment to be executed as of the date signed below.

Date: 19/10/2020

  
Matthew Michael Day

Date: 16/10/20

  
Samira Bintu Kazemi

Assignment to SP6662US

For SPTS Technologies Limited:

Date: .....

.....  
**Signature**

.....  
**Name**

.....  
**Title**

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**RECORDED: 11/10/2020**

**PATENT  
REEL: 054329 FRAME: 0235**